Serial No. 09/434,985 Third Preliminary Amendment

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| 1 | $\frac{1}{26}$. The power processing device according to claim $\frac{2}{2}$, further |
| 2 | including: |
| 3 | a) a base plate having an active element thereon; and, |
| 4 | b) a lead communicating between the active element on said base plate |
| 5 | and said first set of electrically conductive windings |
| p 2 | The power processing device according to claim 26, wherein said electrically conductive trace in communication with said lead is totally contained between two adjoining layers of said dielectric sheets |
| 1 | 28. A power processing device comprising: |
| 2 | a) a multilayer printed circuit board having multiple layers of |

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- dielectric sheets;
 - b) a magnetic element having,
 - 1) a core extending through said layers of dielectric sheets, and,
 - 2) a set of electrically conductive windings, at least one of said windings_of said set of electrically conductive windings contained between two adjoining layers of said dielectric sheets;
- c) at least one electrically conductive trace, each electrically conductive trace communicating with one of said set of electrically conductive windings and totally contained between two adjoining layers of said dielectric sheets. - -

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| 1 | 27. The power processing device according to claim 28, further |
| 2 | including an active element secured to said multilayered printed circuit board |
| 3 | and connected to the set of electrically conductive windings |
| 1 | 25 30. The power processing device according to claim 29, further |
| 2 | including: |
| 3 | a) a heat sink connected to one face of said multilayered printed |
| 4 | circuit board opposing said active element; and, |
| 7 | b) a thermal via thermally connecting said active element and the heat |
| NB. | sink 24 - 31. The power processing device according to claim 28, further |
| 1 | 31. The power processing device according to claim 28, further |
| 2 | including: |
| 3 | a) a base plate having an active element thereon; and, |
| 4 | b) a lead communicating between the active element on said base plate |
| 5 | and said set of electrically conductive windings |
| | A 20 |
| 1 | 32. The power processing device according to claim 31, wherein said |
| 2 | electrically conductive trace in communication with said lead is totally |

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REMARKS

contained between two adjoining layers of said dielectric sheets. - -

By this third preliminary amendment, claims 24-32 have been added. No new matter is involved as the original specification, drawings, and claims fully support these claims.